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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
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10/593,644

09/21/2006

Toshiyuki Mihara

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KRATZ, QUINTOS & HANSON, LLP  
1420 K Street, N.W.  
Suite 400  
WASHINGTON, DC 20005

EXAMINER

SALZMAN, KOURTNEY R

ART UNIT

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1795

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**Please find below and/or attached an Office communication concerning this application or proceeding.**

The time period for reply, if any, is set in the attached communication.

<b>Office Action Summary</b>	<b>Application No.</b> 10/593,644	<b>Applicant(s)</b> MIHARA ET AL.	
	<b>Examiner</b> KOURTNEY R. SALZMAN	<b>Art Unit</b> 1795	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

### Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

### Status

- 1) ☒ Responsive to communication(s) filed on 07 April 2008.
- 2a) ☒ This action is **FINAL**.                      2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

### Disposition of Claims

- 4) ☒ Claim(s) 1-9 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.
- 5) ☐ Claim(s) \_\_\_\_\_ is/are allowed.
- 6) ☒ Claim(s) 1-9 is/are rejected.
- 7) ☐ Claim(s) \_\_\_\_\_ is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

### Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on \_\_\_\_\_ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.  
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

### Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All    b) ☐ Some \*    c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
  2. ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
  3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

\* See the attached detailed Office action for a list of the certified copies not received.

### Attachment(s)

- |  |   |
|--|---|
| 1) <input type="checkbox"/> Notice of References Cited (PTO-892)                     | 4) <input type="checkbox"/> Interview Summary (PTO-413)           |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | Paper No(s)/Mail Date. _____                                      |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08)          | 5) <input type="checkbox"/> Notice of Informal Patent Application |
| Paper No(s)/Mail Date _____  | 6) <input type="checkbox"/> Other: _____                          |

## **DETAILED ACTION**

### ***Response to Amendment***

1. The amendment filed April 7, 2008 has been entered and fully considered.
2. Claims 1-9 remain pending in the application.
3. The 35 USC 103 rejections are withdrawn in light of the applicant's amendments to claims 1 and 2.

### ***Information Disclosure Statement***

4. The information disclosure statement filed March 11, 2008 fails to comply with 37 CFR 1.97(c) because it lacks a statement as specified in 37 CFR 1.97(e). It has been placed in the application file, but the information referred to therein has not been considered.
5. The information disclosure statement filed March 11, 2008 fails to comply with 37 CFR 1.97(c) because it lacks the fee set forth in 37 CFR 1.17(p). It has been placed in the application file, but the information referred to therein has not been considered.

### ***Claim Rejections - 35 USC § 103***

6. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.
7. Claims 1, 3, 4, 6 and 7 rejected under 35 U.S.C. 103(a) as being unpatentable over TAKAGI et al(US 4,443,650), in view of FUNAHASHI et al(JP Publication number 2003-306381) and MIZUTANI (JP Publication number 2003-008086).

TAKAGI et al teaches a thermoelectric converter element comprising p-type and n-type semiconductor films and a flexible insulating substrate (column 2, line 58 -

column 3, line 8). These films are electrically connected as "one ends of the films are connected to each other or short circuited to each other".(column 2, lines 62-65) TAKAGI et al states, in column 3, lines 1-6, the films can be connected by a metallic layer or directly to one another through contact. Figures 4A and 4B show the films connected utilizing a metal layer, where the p-type and n-type layers are reference number 1 and 2 respectively. Both layers are shown as connected to the insulating substrate, reference number 6.

TAKAGI et al teaches the use of conventional thermoelectric films in column 8, line 61 – column 9, line 12. However, TAKAGI et al fails to teach the composition of the p-type and n-type layers are complex oxides.

FUNAHASHI et al teaches a p-type semiconductor made of complex oxide as disclosed in the instant application as the second equation. The complex oxide is shown in the abstract to have the formula  $\text{Bi}_{(1.6-2.2)}\text{Pb}_{(0-0.5)}\text{Sr}_{(1.6-2.2)}\text{Co}_2\text{O}_{(8.6-9.4)}$ . This corresponds to the equation listed in the instant application as the  $\text{M}^1$  constituent is strontium or Sr as listed as a viable option in the instant application. All the subscript ranges and possible element selections listed are contained within the limitations of claim 1, formula 2. The  $\text{M}^2$  element is not required to be present in formula 2 because subscript zero falls within the range designated for variable d of the instant application.

At the time of invention, it would be obvious to construct the p-type semiconductor described in TAKAGI et al of the complex oxide material of FUNAHASHI et al because this composition allows for optimized features of the thermoelectric device. FUNAHASHI et al states in the abstract that the use of this oxide having "excellent thermoelectric conversion performance." This is a highly desirable trait in a thermoelectric device. Therefore, the use of the material described in FUNAHASHI et al in the structure of TAKAGI et al is obvious because it improves the functional properties of the thermoelectric device, an obvious goal of the thermoelectric industry.

TAKAGI et al and FUNAHASHI et al fail to disclose the n-type layer made of complex oxides.

MIZUTANI teaches an n-type semiconductor film as in formula 3 of the instant application. The complex oxide is shown in the abstract to have the formula  $L_p A_{(p-1)} (Co_z Ni_q B_{(1-z-q)})_x O_y$ . The L stated to be a rare earth element, which in the abstract, is to be one of a lanthanide series. The rare earth element can, per MIZUTANI, be present in the compound between 0.5-1.5. The formula element A is stated to be an alkaline earth metal is to be one of the group of "calcium (Ca), strontium (Sr) and barium (Ba)" and can be present as 0, as required in the formation of the n-type of the instant application. The formula element Co is to be present between 0-.5. The formula element Ni is to be present between .5-

1.2. The B term will be present with a subscript of zero. Finally the oxygen will be present between 2-4. The final formula required to fulfill the instant application could be, as an example,  $\text{LNiCo}_{.5}\text{O}_3$ . All the subscript ranges and possible element selections listed are contained within the limitations of claim 1, formula 3.

At the time of invention, it would be obvious to combine the thermoelectric device of TAKAGI et al modified by the p-type thermoelectric material of FUNAHASHI et al with the addition of a complex oxide n-type thermoelectric material of MIZUTANI because this composition allows for optimized features of the thermoelectric device. In the abstract, MIZUTANI teaches the composite oxide to have good electrical conductivity, a high thermoelectromotive force and excellent stability. Therefore, it would be obvious to one of ordinary skill in the art to combine the thermoelectric structure of TAKAGI et al modified to include the p-type thermoelectric material of FUNAHASHI et al with the n-type thermoelectric material of MIZUTANI because the n-type material provides for an electrically conductive stable material for use.

Regarding claim 2, in conjunction with the previous rejection of claim 1, the p-type thermoelectric material as described in FUNAHASHI et al and discussed in the rejection of claim 1, is applicable to this material designation. The description

and rejection of the n-type thermoelectric material described in MIZUTANI and the rejection of claim 1, is also applicable to the rejection of claim 2 as well.

Regarding claim 3, in conjunction with the previous rejection of claim 1, TAKAGI et al teaches, in column 3, lines 1-9, multiple ways to connect the two conductive films. The first is described as "one ends of the films may be connected to each other through a metallic layer". The second is described as, "one ends of the films may be directly connected to each other by being overlaid one above the other". Both correspond to possible electrical connections describe in the instant application.

Regarding claim 4, in conjunction with the previous rejection of claim 1, TAKAGI et al shows in figures 4A and 4B, as discusses in column 8, lines 3-4, that the n-type and p-type, reference numbers 1 and 2 respectively, are formed on the substrate, shown as reference number 6. They are shown to be on the same surface of the substrate.

Regarding claim 6, in conjunction with this previous rejection of claim 1, FUNAHASHI et al states in paragraph 8, the complex oxide as described has "a Seebeck coefficient of 100  $\mu\text{V}/\text{k}$  or more at a temperature of 300°C or higher". The Seebeck coefficient is a measure of thermoelectric force. A temperature of

300°C is equivalent to a temperature of 573K, covering within the range described in the instant claim.

Regarding claim 7, in conjunction with the previous rejection of claim 1, the combination of the structure of TAKAGI et al with the thermoelectric materials described in FUNAHASHI et al and MIZUTANI, yield a substantially similar structure and material to that described in the instant application. Therefore, the thermoelectric element would have the same electrical resistive properties, including an electrical resistance of 1kΩ or lower in a temperature range of 293K to 1073K. (MPEP 2112)

8. Claims 5, 8 and 9 is rejected under 35 U.S.C. 103(a) as being unpatentable over TAKAGI et al(US 4,443,650), FUNAHASHI et al(JP Publication number 2003-306381) and MIZUTANI (JP Publication number 2003-008086) as applied to claim 1 above, and further in view of BUIST (US 4,859,250).

TAKAGI et al, FUNAHASHI et al and MIZUTANI teach all the limitations of claim 1.

The combination of the structure of TAKAGI et al with the materials described in FUNAHASHI et al and MIZUTANI fails to teach possible materials for the insulating substrate and how the thermoelectric elements attach together.



BUIST teaches the use of a thermoelectric device within a heat pump or power source device which places the n-type or p-type semiconductors on flexible or inflexible substrates. In the abstract, BUIST states, "the film type elements are formed on substrates of such flexible, electrically insulation material, as, for example MYLAR and TEFLON; while for inflexible unites the elements are formed on substrates of such materials as... plastics." MYLAR and TEFLON are trade names of polymers considered to be plastics.

It would be obvious to one of ordinary skill in the art to combine the semiconductor structure and materials of TAKAGI et al, FUNAHASHI et al and MIZUTANI with the plastic substrate of BUIST because there are only a finite number of insulating materials for use as the thermoelectric substrate. Plastics are a principle component of a group of any insulating materials. Thus, it would have been obvious to one of ordinary skill in the art to use the plastic substrate of BUIST as the insulating substrate material as described in TAKAGI et al, FUNAHASHI et al and MIZUTANI, as a person with ordinary skill has good reason to pursue the known options within his or her technical grasp. In turn, because the use of plastic as the substrate has the insulating properties of predicted by the combination of TAKAGI et al, FUNAHASHI et al and MIZUTANI, it would have been obvious to use plastic in the thermoelectric element.

Regarding claim 8, in conjunction with the previous rejection of claim 1, BUIST teaches in figure 3A the location and connection of p-type and n-type semiconductors. The thermoelectric element includes the n-type conductor (reference number 64), p-type conductor (reference number 66) and connection between the two (reference number 82). Each element is shown connected in series. The unconnected end of the p-type semiconductor is electrically connected to the unconnected end of the n-type semiconductor using lead, reference number 80. This method of connection is conventional to one of ordinary skill in this art. Therefore, the connection of an n-type and p-type semiconductor via an unconnected end would be obvious.

Regarding claim 9, in conjunction with the previous rejections of claims 1 and 8, BUIST utilizes the configuration of thermoelectric elements, as in the rejection of claim 8, shown in figure 3A, and forms the elements into strips affixed to the flexible plastic substrate. In column 5, lines 5-8, BUIST teaches, "the thermoelectric elements are folded to combine all cold strings on a first plane and all hot strips on a second plane opposing the first plane of cold strips". Shown in figure 4, the hot side is compiled on one end of the modulus, while the cold side is compiled opposite.

At the time of invention, one of ordinary skill in the art would find it obvious to organize the structure and materials of TAGAKI et al, FUNAHASHI et al and

MIZUTANI in the manner of BUIST because the layout of similar temperature elements on opposing sides is obvious. It is intuitive to place the cold strip elements on one side of the thermoelectric modulus and the hot elements on the other because a thermoelectric device is usually used to generate power from a temperature gradient on two different sides of the device. The organization of the elements taught by TAGAKI et al, FUNAHASHI et al and MIZUTANI in the pattern of BUIST is obvious as it allows the thermoelectric device to function efficiently.

***Response to Arguments***

9. Applicant's arguments filed April 7, 2008 have been fully considered but they are not persuasive.

10. Applicant argues on page 8 of the arguments in the third full paragraph, the references applied in the first office action are not applicable as they do not include the materials disclosed as amended in the submission on April 7, 2008.

a. Examiner has addressed this concern by presenting new grounds of rejection as required by the amendment in this office action.

11. Applicant argues at the bottom of page 8 and the top of page 9 that the combination shown in the instant application provides unexpected results over the prior art.

b. The applicant has not shown data or any support for these claims. The claim to the exhibition of "a high thermoelectric conversion efficiency and satisfactory electrical conductivity" found in the response from the applicant is

relative and abstract. This argument is not persuasive as it provides no support or proof of these claims to patentability and novelty.

12. Applicant argues on page 10 of the arguments the references applied in the first office action are not applicable as they do not include the materials disclosed as amended in the submission on April 7, 2008.

c. Examiner has addressed this concern by presenting new grounds of rejection as required by the amendment in this office action.

### ***Conclusion***

13. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire **THREE MONTHS** from the mailing date of this action. In the event a first reply is filed within **TWO MONTHS** of the mailing date of this final action and the advisory action is not mailed until after the end of the **THREE-MONTH** shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than **SIX MONTHS** from the date of this final action.

14. Any inquiry concerning this communication or earlier communications from the examiner should be directed to KOURTNEY R. SALZMAN whose telephone number is

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(571)270-5117. The examiner can normally be reached on Monday to Thursday 6:30AM-5PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Patrick Ryan can be reached on (571) 272-1292. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

krs

7/21/2008

/PATRICK RYAN/

Supervisory Patent Examiner, Art Unit 1795